

PCIM Europe 2018, Nuremberg – Hall 9 – Stand 301

Toshiba to exhibit multiple exciting new products at PCIM Europe

MOSFETs, photocouplers and photorelays to be featured on booth

Düsseldorf, Germany, 14th **May 2018** – Toshiba Electronic Devices & Storage Corporation ("Toshiba") announces their participation in PCIM Europe (Power Conversion and Intelligent Motion) 2018 where they will showcase their comprehensive portfolio of power semiconductor devices and solutions.

Included on the booth will be several extensions to existing product lines as well as some completely new products and technologies:-

- The latest generation of 30-100V class LV MOSFETs delivering best in class efficiency
- 600V planar MOSFETs (PIMOS IX) with low noise, high efficiency & avalanche ruggedness
- The latest automotive MOSFETs line-up
- Automotive photocouplers with IC-, transistor-, photovoltaic- and MOSFET-output
- Photocouplers for high-speed data transmission, gate driving, and isolation amplifiers
- Photorelays for mechanical relay replacement
- Motor control solutions for improved efficiency and higher precision
- Toshiba's innovative circuit technology for improving energy efficiency (A-SRB™)

Toshiba also anticipate unveiling two new 40V N-channel MOSFETs designed specifically for demanding automotive applications during the show.

PCIM Europe 2018 runs from 5th to 7th June 2018 in Nuremberg, Germany and Toshiba can be found in Hall 9, on Booth 301 where their technical team will be available to discuss new and existing products and answer customer questions.



About Toshiba Electronics Europe

<u>Toshiba Electronics Europe</u> (TEE) is the European electronic components business of <u>Toshiba Electronic Devices and Storage Corporation</u>. TEE offers a broad IC and discrete product line including high-end memory, microcontrollers, ASICs and ASSPs for automotive, multimedia, industrial, telecoms and networking applications. The company also has a wide range of power semiconductor solutions as well as storage products including HDDs, SSDs, SD Cards and USB sticks.

TEE was formed in 1973 in Neuss, Germany, providing design, manufacturing, marketing and sales and now has headquarters in Düsseldorf, Germany, with branch offices in France, Italy, Spain, Sweden and the United Kingdom. TEE employs approximately 300 people in Europe. Company president is Mr Akira Morinaga.

For more company information visit TEE's web site at www.toshiba.semicon-storage.com.

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